Extremely Accurate Power Surveillance, Software Monitoring and Sleep Mode Detection

Features

- Can-bus sleep mode detector
- Standby mode, maximum current 50 μA
- Reset output guaranteed for V_{DD} voltage down to 1.2 V
- Comparator for voltage monitoring, voltage reference 1.275 V
- ± 2.0% voltage reference accuracy at +25 °C
- ± 2.7% voltage reference accuracy from -40 to +85 °C (3 to 5.5 V)
- Programmable reset voltage monitoring
- Programmable power-on reset (POR) delay
- Watchdog with programmable time windows guarantees a minimum time and a maximum time between software clearing of the watchdog
- Time base accuracy ± 10%
- System enable output offers added security
- TTL / CMOS compatible
- -40 to +85 °C temperature range
- On request extended temperature range, -40 to +125 °C
- DIP8 and SO8 packages

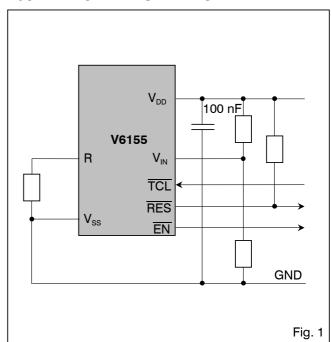
Description

The V6155 offers a high level of integration by voltage monitoring and software monitoring in an 8 lead package. A comparator monitors the voltage applied at the $V_{\scriptscriptstyle IN}$ input comparing it with an internal 1.275 V reference. The power-on reset function is initialized after V_{IN} reaches 1.275 V and takes the reset output inactive after T_{POR} depending of external resistance. The reset output goes active low when the VIN voltage is less than 1.275 V. The RES and EN outputs are guaranteed to be in a correct state for a supply voltage as low as 1.2 V. The watchdog function monitors software cycle time and execution. If software clears the watchdog too quickly (incorrect cycle time) or too slowly (incorrect execution), it will cause the system to be reset. The system enable output prevents critical control functions being activated until software has successfully cleared the watchdog three times. Such a security could be used to prevent motor controls being energized on repeated resets of a faulty system. If the microcontroller does not work that means no signal on the TCL input the V6155 goes in a standby mode (CAN-bus sleep detector).

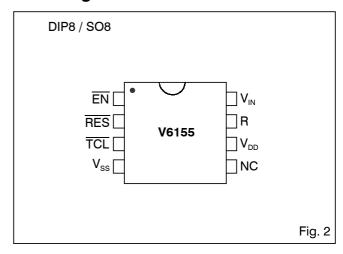
Applications

- Automotive systems
- Cellular telephones
- Security systems
- Battery powered products
- High efficiency linear power supplies
- Industrial electronics

Typical Operating Configuration



Pin Assignment





Absolute Maximum Ratings

Parameter	Symbol	Conditions
Maximum voltage at V _{DD}	V_{DDmax}	V _{ss} + 8 V
Minimum voltage at V _{DD}	V_{DDmin}	V _{SS} – 0.3 V
Max. voltage at any signal pin	V _{MAX}	$V_{DD} + 0.3 V$
Min. voltage at any signal pin	V_{MIN}	V _{ss} – 0.3 V
Storage temperature	T _{STO}	-65 to+150 °C
Electrostatic discharge max. to		
MIL-STD-883C method 3015	V_{Smax}	1000 V
Max. soldering conditions	T _{Smax}	250 °C x 10 s

Table 1

Stresses above these listed maximum ratings may cause permanent damage to the device. Exposure beyond specified operating conditions may affect device reliability or cause malfunction.

Handling Procedures

This device has built-in protection against high static voltages or electric fields; however, anti-static precautions should be taken as for any other CMOS component. Unless otherwise specified, proper operation can only occur when all terminal voltages are kept

within the supply voltage range. At any time, all inputs must be tied to a defined logic voltage level.

Operating Conditions

Parameter	Symbol	Min.	Тур.	Мах.	Units
Operating temperature ¹⁾	T _A	-40		+125	°C
Supply voltage ²⁾	V _{DD}	1.2		7.0	V
RES & EN guaranteed3)	V _{DD}	1.2			V
Comparator input					
voltage	V _{IN}	0		V_{DD}	V
RC-oscillator					
programming	R	10		1000	kΩ

Table 2

- ¹⁾ The maximum operating temperature is confirmed by sampling at initial device qualification. In production, all devices are tested at +85 °C. On request devices tested at +125 °C can be supplied
- $^{2)}$ A 100 nF decoupling capacitor is required on the supply voltage V_{DD} for stability.
- ³⁾ RES must be <u>pulled up</u> externally to V_{DD} even if it is unused. (Note: RES and EN are used as inputs by EM test.)

Electrical Characteristics

 $3 \leq V_{\text{DD}} \leq 5.5$ V, C = 100 nF, $T_{\text{A}} =$ -40 to +85 °C, unless otherwise specified

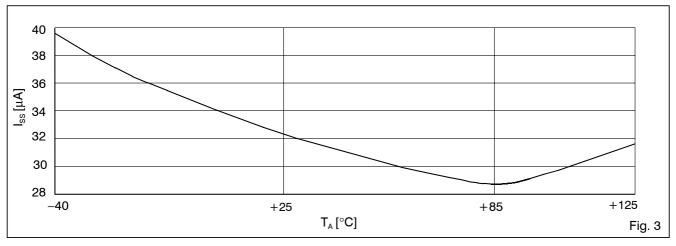
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Supply current in standby mode	I _{ss}	$R_{EXT} = don't care, \overline{TCL} = V_{DD}$				
(switched to R _{INT})		$V_{IN} = V_{DD}$		34	50	μΑ
Supply current	I _{ss}	$R_{EXT} = 100 \text{ k}\Omega, \text{ I/Ps at V}_{DD}$		55	100	μΑ
RES and EN						
Output Low Voltage	Vol	$V_{DD} = 4.5 \text{ V}, I_{OL} = 20 \text{ mA}$		0.4		V
	V _{OL}	$V_{DD} = 4.5 \text{ V}, I_{OL} = 8 \text{ mA}$		0.2	0.4	V
	V_{OL}	$V_{DD} = 2.0 \text{ V}, I_{OL} = 4 \text{ mA}$		0.2	0.4	V
	V_{OL}	$V_{DD} = 1.2 \text{ V}, I_{OL} = 0.5 \text{ mA}$		0.05	0.2	V
EN						
Output High Voltage	V_{OH}	$V_{DD} = 4.5 \text{ V}, I_{OH} = -1 \text{mA}$	3.5	4.1		V
	V_{OH}	$V_{DD} = 2.0 \text{ V}, I_{OH} = -100 \mu\text{A}$	1.8	1.9		V
	V_{OH}	$V_{DD} = 1.2 \text{ V}, I_{OH} = -30 \mu\text{A}$	1.0	1.1		V
TCL and V _{IN}		July 7 Gill				
TCL Input Low Level	V _{IL}		V_{ss}		0.8	V
TCL Input High Level	V_{IH}		2.0		$V_{\scriptscriptstyle DD}$	V
Leakage current TCL input	ILI	$V_{SS} \le V_{TCL} \le V_{DD}$		0.05	1	μΑ
V _{IN} input resistance	R _{VIN}	VSS — VICL — VDD		100		ΜΩ
Comparator reference ¹⁾	V_{REF}	T _Δ = +25 °C	1.25	1.275	1.30	V
	V_{REF}		1.24		1.31	V
	V _{REF}	T _A = -40 to +125 °C	1.22		1.31	V
Comparator hysteresis ¹	V_{HY}	1.4 10 10 1 120 0		2		mV

Table 3

¹⁾ The comparator reference is the power-down reset threshold. The power-on reset threshold equals the comparator reference voltage plus the comparator hysteresis (see Fig. 6).



$I_{\rm SS}$ Standby versus Temperature at $V_{\rm DD} = 5.5~V$



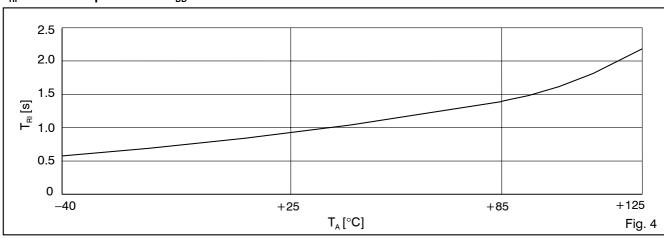
Timing Characteristics

 $V_{\text{DD}} = 5.0 \ \text{V} \pm 3\%, \, C = 100 \ \text{nF}, \, T_{\text{A}} = -40 \ \text{to} + 85 \ ^{\circ}\text{C}, \, \text{unless otherwise specified}$

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Propagation delays:						
TCL to Output Pins	T _{DIDO}			250	500	ns
V _{IN} sensitivity	T _{SEN}		1	5	20	μs
Logic Transition Times on all Output Pins	T _{TR}	Load 10 kΩ, 50 pF		30	100	ns
Power-on Reset delay	T _{POR}	$R_{EXT} = 110 \text{ k}\Omega, \pm 1\%$	90	100	110	ms
Watchdog Time	T _{WD}	$R_{EXT} = 110 \text{ k}\Omega, \pm 1\%$	90	100	110	ms
Open Window Percentage	OWP	EXI		$\pm 0.2~\mathrm{T_{WD}}$		
Closed Window Time	T _{CW}			0.8 T _{WD}		
	T _{CW}	$R_{EXT} = 110 \text{ k}\Omega, \pm 1\%$	72	80	88	ms
Open Window Time	T _{ow}	, ,		$0.4 T_{WD}$		
	T _{ow}	$R_{EXT} = 110 \text{ k}\Omega, \pm 1\%$	36	40	44	ms
Watchdog Reset Pulse	T _{WDR}	TIEXT TIO KEET, = 1 70		$T_{WD}/40$		
	T _{WDR}	$R_{EXT} = 110 \text{ k}\Omega, \pm 1\%$		2.5		ms
T _{CL} Input Pulse Width	T _{TCL}	11EX1 110 K32, ±170	150			ns
Reset Pulse when switched to R internal	T _{RI}		0.3	0.9	2.3	s
Watchdog Reset Pulse with R internal (R _I)	T _{RIR}			T _{RI} /320		s

Table 4

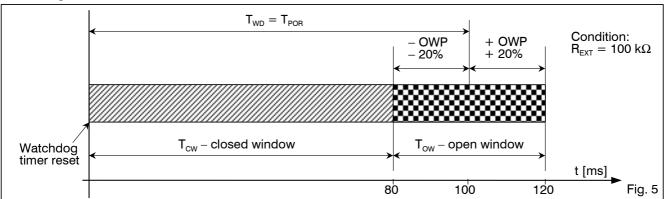
T_{RI} versus Temperature at $V_{\text{DD}} = 5 \text{ V}$



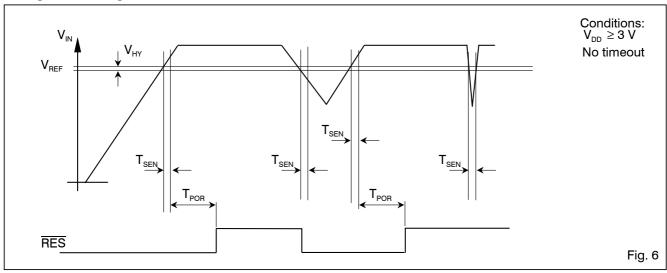


Timing Waveforms

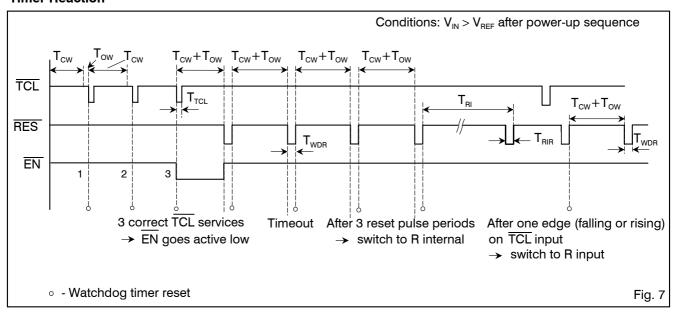
Watchdog Timeout Period



Voltage Monitoring

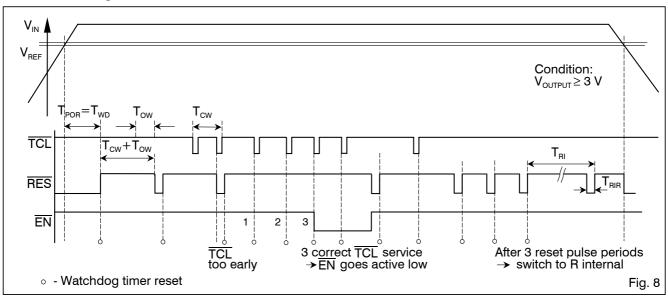


Timer Reaction

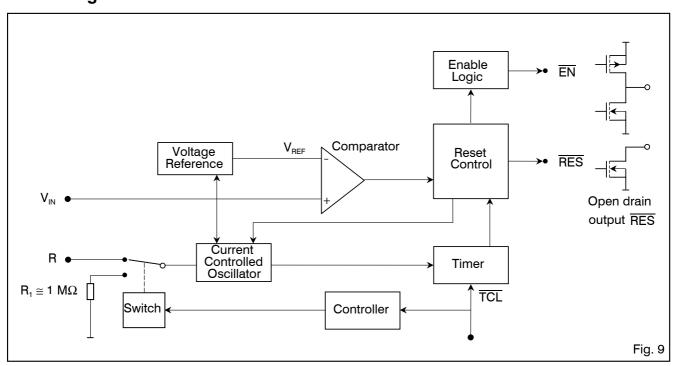




Combined Voltage and Timer Reaction



Block Diagram





Pin Description

Pin	Name	Function
1	EN	Push-pull active low enable output
2	RES	Open drain active low reset output.
		RES must be pulled up to V _{DD}
		even if unused
3	TCL	Watchdog timer clear input signal
4	V_{ss}	GND terminal
5	NC	No connection
6	V_{DD}	Voltage supply
7	R	R _{EXT} input for RC oscillator tuning
8	V _{IN}	Voltage comparator input

Table 5

Functional Description

VIN Monitoring

The power-on reset and the power-down reset are generated as a response to the external voltage level applied on the $V_{\rm IN}$ input. The $V_{\rm DD}$ voltage at which reset is asserted or released is determined by the external voltage divider between $V_{\rm DD}$ and $V_{\rm SS}$, as shown on Fig. 10. A part of $V_{\rm DD}$ is compared to the internal voltage reference. To determine the values of the divider, the leakage current at $V_{\rm IN}$ must be taken into account, as well as the current consumption of the divider itself. Low resistor values will need more current, but high resistor values will make the reset threshold less accurate at high temperature, due to a possible leakage current at the $V_{\rm IN}$ input. The sum of the two resistors should stay below 300 kΩ. The formula is: $V_{\rm RESET} = V_{\rm REF}$ * (1 + R_1/R_2).

Example: choosing $R_1 = 100 \text{ k}\Omega$ and $R_2 = 39 \text{ k}\Omega$ will result in a V_{DD} reset threshold of 4.54 V (typ.).

At power-up the reset output (\overline{RES}) is held low (see Fig. 6). When V_{IN} becomes greater than V_{REF}, the \overline{RES} output is held low for an additional power-on reset (POR) delay which is equal to the watchdog time T_{WD} (typically 100 ms with an external resistor of 110 k Ω connected at R pin). The POR delay prevents repeated toggling of \overline{RES} even if V_{IN} and the INPUT voltage drops out and recovers. The POR delay allows the microprocessor's crystal oscillator time to start and stabilize and ensures correct recognition of the reset signal to the microprocessor.

The \overline{RES} output goes active low generating the power-down reset whenever V_{IN} falls below V_{REF} . The sensitivity or reaction time of the internal comparator to the voltage level on V_{IN} is typically 5 μ s.

Timer Programming

The on-chip oscillator needs an external resistor R_{EXT} connected between the R pin and V_{SS} (see Fig. 10). It allows the user to adjust the power-on reset (POR) delay, watchdog time T_{WD} and with this also the closed and open time windows as well as the watchdog reset pulse width $(T_{\text{WD}}/40)$.

With $R_{EXT} = 110 \text{ k}\Omega$, the typical values are:

Note the current consumption increases as the frequency increases.

Watchdog Timeout Period Description

The watchdog timeout period is divided into two parts, a "closed" window and an "open" window (see Fig. 5) and is defined by two parameters, T_{WD} and the Open Window Percentage (OWP).

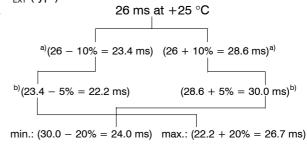
The closed window starts just after the watchdog timer resets and is defined by $T_{\text{CW}} = T_{\text{WD}} - \text{OWP}(T_{\text{WD}})$.

The open window starts after the closed time window finishes and lasts till T_{WD} + OWP(T_{WD}). The open window time is defined by T_{OW} = 2 x OWP(T_{WD}).

For example if $T_{WD}=100$ ms (actual value) and OWP = \pm 20% this means the closed window lasts during first the 80 ms ($T_{CW}=80$ ms = 100 ms – 0.2 (100 ms)) and the open window the next 40 ms ($T_{OW}=2$ x 0.2 (100 ms) = 40 ms). The watchdog can be serviced between 80 ms and 120 ms after the timer reset. However as the time base is \pm 10% accurate, software must use the following calculation for servicing signal TCL during the open window:

Related to curves (Fig. 11 to Fig. 21), especially Fig. 20 and Fig. 21, the relation between T_{WD} and R_{EXT} could easely be defined. Let us take an example describing the variations due to production and temperature:

- 1. Choice, $T_{WD} = 26 \text{ ms.}$
- 2. Related to Fig. 21, the coefficient (T $_{WD}$ to R $_{EXT}$) is 1.025 where R $_{EXT}$ is in k Ω and T $_{WD}$ in ms.
- 3. R_{EXT} (typ.) = 26 x 1.025 = 26.7 k Ω .



The ratio between $T_{WD} = 26$ ms and the (\overline{TCL} period) = 25.4 ms is 0.975.

Then the relation over the production and the full temperature range is, \overline{TCL} period = 0.975 x T_{WD}

or
$$\overline{\text{TCL}}$$
 period = $\frac{0.975 \times R_{\text{EXT}}}{1.025}$, as typical value.

- a) While PRODUCTION value unknown for the customer when $R_{EXT} \neq 110 \text{ k}\Omega$.
- b) While operating TEMPERATURE range $-40 \,^{\circ}\text{C} \le \, T_{\text{A}} \le +85 \,^{\circ}\text{C}$.



5. If you fixed a \overline{TCL} period = 26 ms

⇒
$$R_{EXT} = \frac{26 \times 1.025}{0.975} = 27.3 \text{ k}\Omega$$

If during your production the T_{WD} time can be measured at $T_A = +25~^{\circ}C$ and the μC can adjust the \overline{TCL} period, then the \overline{TCL} period range will be much larger for the full operating temperature.

Timer Clearing and RES Action

The watchdog circuit monitors the activity of the processor. If the user's software does not send a pulse to the \overline{TCL} input within the programmed open window timeout period, a short watchdog \overline{RES} pulse is generated which is equal to $T_{WD}/40 = 2.5$ ms typically (see Fig. 7).

With the open window constraint, new security is added to conventional watchdogs by monitoring both software cycle time and execution. Should software clear the watchdog too quickly (incorrect cycle time) or too slowly (incorrect execution) it will cause the system to be reset. If the software is stuck in a loop which includes the routine to clear the watchdog, then a conventional watchdog will not reset even though the software is malfunctioning; the V6155 will generate a system reset because the watchdog is cleared too quickly.

If no TCL pulse <u>is applied</u> before the closed and open windows expire, RES will start to generate square waves of period ($T_{\text{CW}} + T_{\text{OW}} + T_{\text{WDR}}$). The watchdog will remain in this state until the next TCL falling edge appears during an open window, or until a <u>fresh</u> power-up sequence. The system enable output, EN, can be used to prevent critical control functions being activated in the event of the system going into this failure mode (see section "Enable - EN Output").

The RES output must be pulled up to V_{DD} even if that output is not used by the system (see Fig. 10).

Combined Voltage and Timer Action

The combination of voltage and timer actions is illustrated by the sequence of events shown in Fig. 8. On power-up, when the voltage at V_{IN} reaches V_{REF} , the power-on reset, POR, delay is initialized and holds RES active for the time of the POR delay. A TCL pulse will have no effect until this power-on reset delay is

completed. When the risk exists that \overline{TCL} temporarily floats, e.g. during T_{POR} , a pull-up to V_{DD} is required on that pin. After the POR delay has elapsed, RES goes inactive and the watchdog timer starts acting. If no \overline{TCL} pulse occurs, RES goes active low for a short time T_{WDR} after each closed and open window period. A \overline{TCL} pulse coming during the open window clears the watchdog timer. When the \overline{TCL} pulse occurs too early (during the closed window), RES goes active and a new timeout sequence starts. A voltage drop below the V_{REF} level for longer than typically 5 μ s, overrides the timer and immediately forces RES active and EN inactive. Any further \overline{TCL} pulse has no effect until the next power-up sequence has completed.

Enable - EN Output

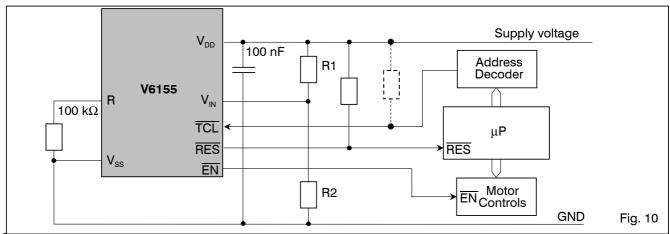
The system enable output, $\overline{\text{EN}}$, is inactive always when RES is active and remains inactive after a $\overline{\text{RES}}$ pulse until the watchdog is serviced correctly 3 consecutive times (i.e. the $\overline{\text{TCL}}$ pulse must come in the open window). After three consecutive services of the watchdog with $\overline{\text{TCL}}$ during the open window, the $\overline{\text{EN}}$ goes active low.

A malfunctioning system would be repeatedly reset by the watchdog. In a conventional system critical motor controls could be energized each time reset goes inactive (time allowed for the system to restart) and in this way the electrical motors driven by the system could function out of control. The V6155 prevents the above failure mode by using the EN output to disable the motor controls until software has successfully cleared the watchdog three times (i.e. the system has correctly restarted after a reset condition).

CAN-Bus Sleep Mode Detector

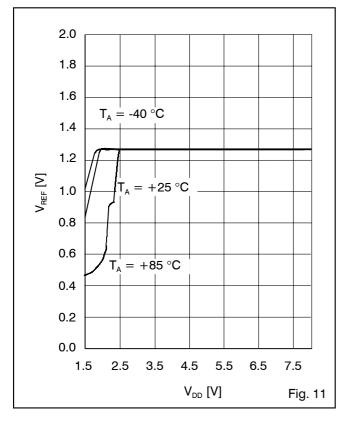
If the microcontroller is in standby mode that means it does not have any pulses on the \overline{TCL} input. After 3 reset pulse periods ($T_{CW} + T_{OW} + T_{WDR}$) on the RES output, the V6155 switches on an internal resistor of 1 M Ω , and it will have a reset pulse of typically 3 ms every 1 second on the RES output. When a \overline{TCL} edge (rising or falling) appears on the \overline{TCL} input or the power supply goes down and up, the V6155 switches to the R input.

Typical Application

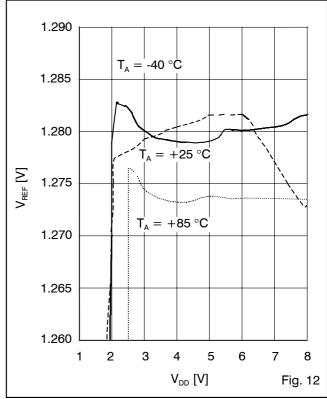




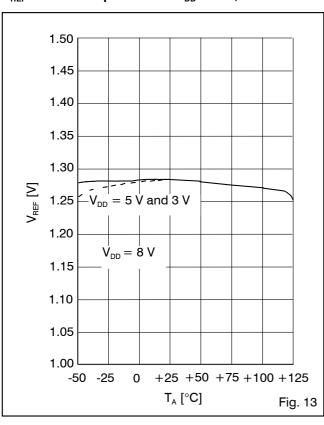
V_{REF} versus V_{DD} at $T_A = -40$ °C, +25 °C, +85 °C



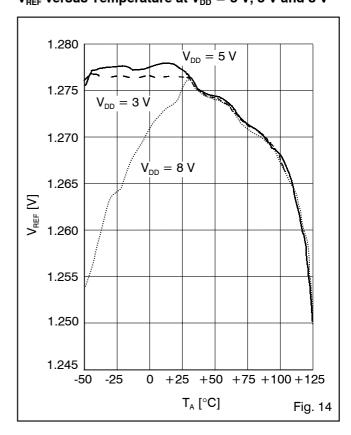
 V_{REF} versus V_{DD} at T_A = -40 °C, +25 °C, +85 °C



 $\rm V_{REF}$ versus Temperature at $\rm V_{DD}$ = 3 V, 5 V and 8 V

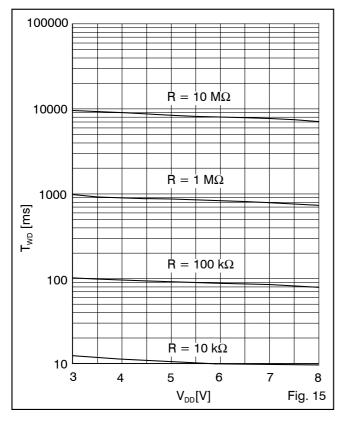


 V_{REF} versus Temperature at $V_{DD}=3~V, 5~V$ and 8 V

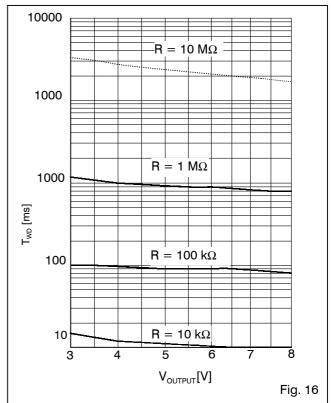




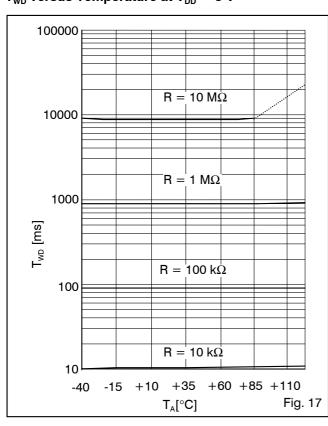
 T_{WD} versus Supply Voltage at $T_A \le +85$ °C



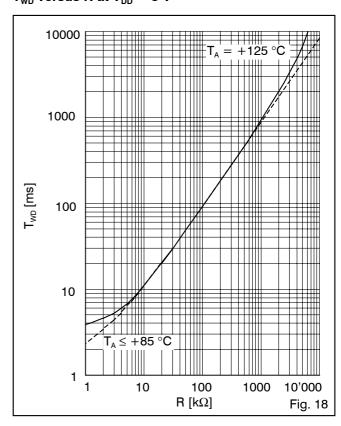
 T_{WD} versus V_{DD} at $T_A = +125~^{\circ}C$



 T_{WD} versus Temperature at $V_{DD} = 5 \text{ V}$

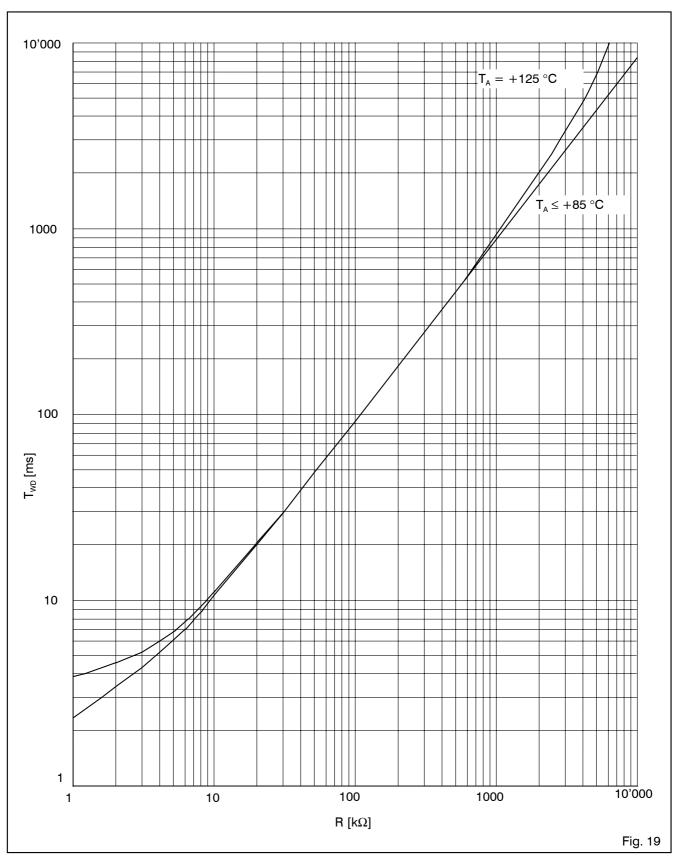


 T_{WD} versus R at $V_{DD} = 5 \text{ V}$



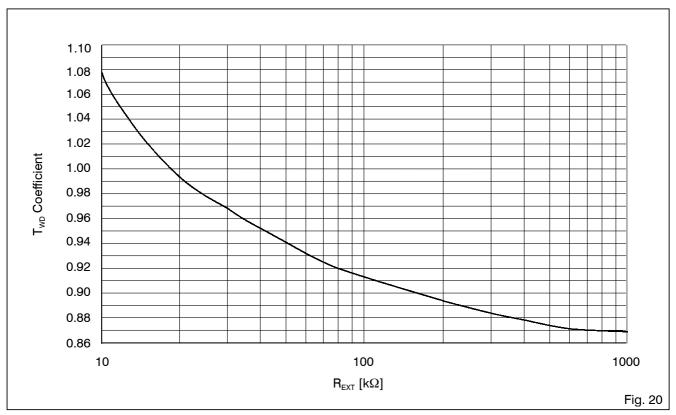


T_{WD} versus R at V_{DD} = 5 V

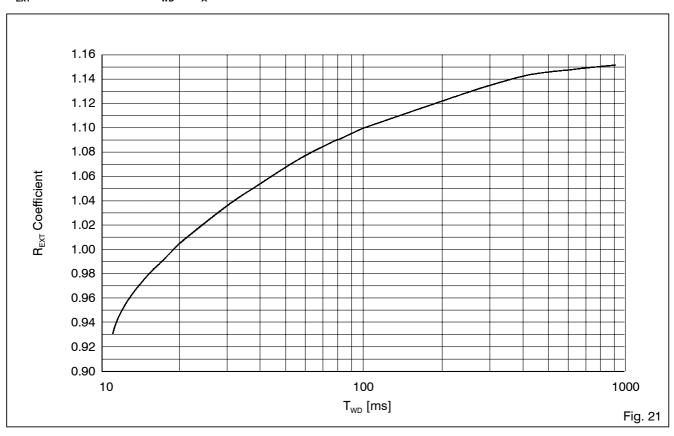




$\rm T_{WD}$ Coefficient versus $\rm R_{EXT}$ at $\rm T_A = +25~^{\circ}C$



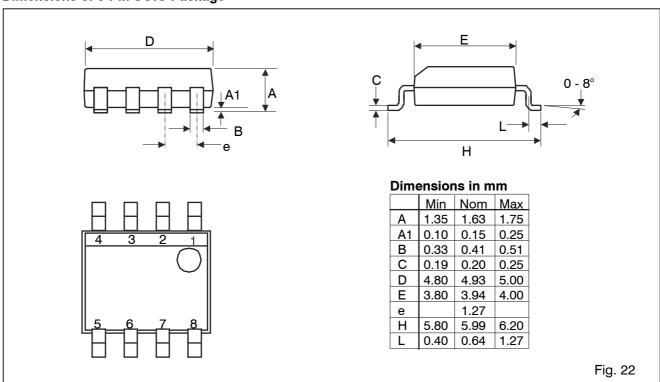
R_{EXT} Coefficient versus T_{WD} at $T_{\text{A}} = +25~^{\circ}\text{C}$



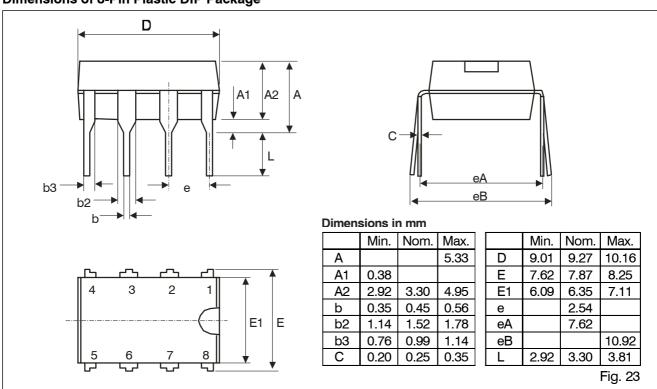


Package Information

Dimensions of 8-Pin SOIC Package



Dimensions of 8-Pin Plastic DIP Package





Ordering Information

When ordering please specify complete part number.

Part Number	Package	Delivery Form	Package Marking	
			(first line)	
V6155DL8A	8-pin plastic DIP	Stick	V6155	
V6155SO8A	8-pin SOIC	Stick	6155V	
V6155SO8B	8-pin SOIC	Tape & Reel	6155V	

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